tle: TEST BOARD DE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY ON AN AUTOMATIC TESTING

EQUIPMENT FOR IC WAFERS Express Mail No. EV336594715US "REPLACEMENT SHEET"

Inventor(s): Guiseppe Di Gregorio et al. Serial No. 10/033,364 Docket No. 856063.678

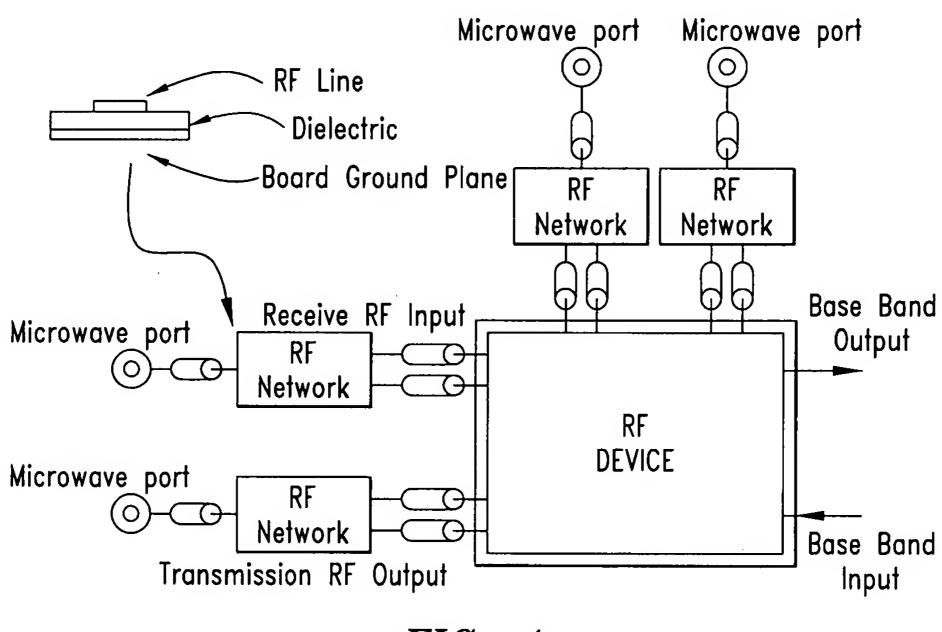


FIG. 1 (Prior Art)

Title: TEST BOARD DE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY ON AN AUTOMATIC TESTING "REPLACEMENT SHEET"

Serial No. 10/033,364 Docket No. 856063.678

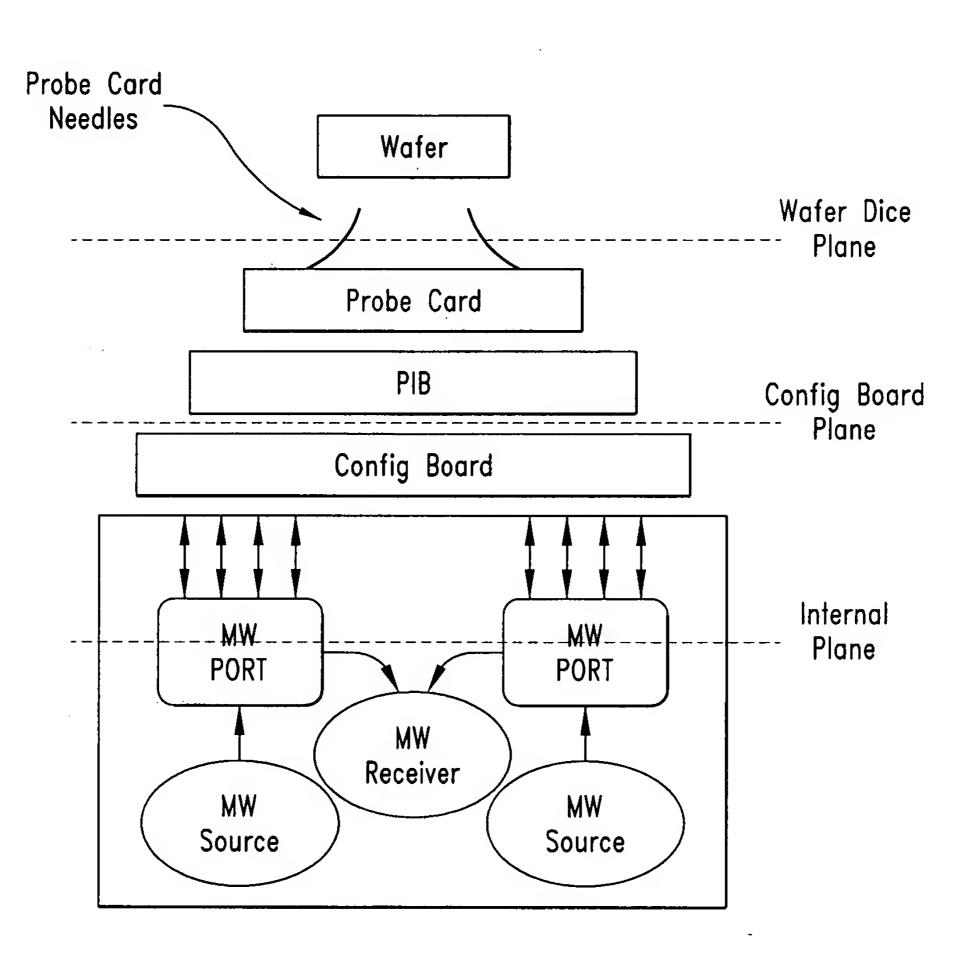


FIG. 2 (Prior Art)

Title: TEST BOARD DE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY ON AN AUTOMATIC TESTING Express Mail No. EV336594715US "REPLACEMENT SHEET"

EQUIPMENT FOR IC WAFERS

Inventor(s): Guiseppe Di Gregorio et al. Serial No. 10/033,364

Docket No. 856063.678

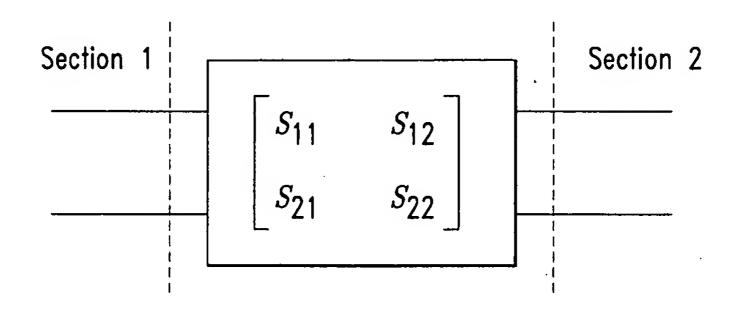


FIG. 3

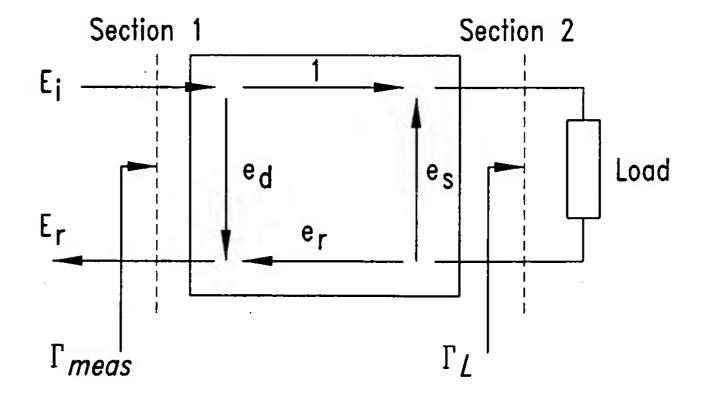


FIG. 4

MAR 0 8 2004 %

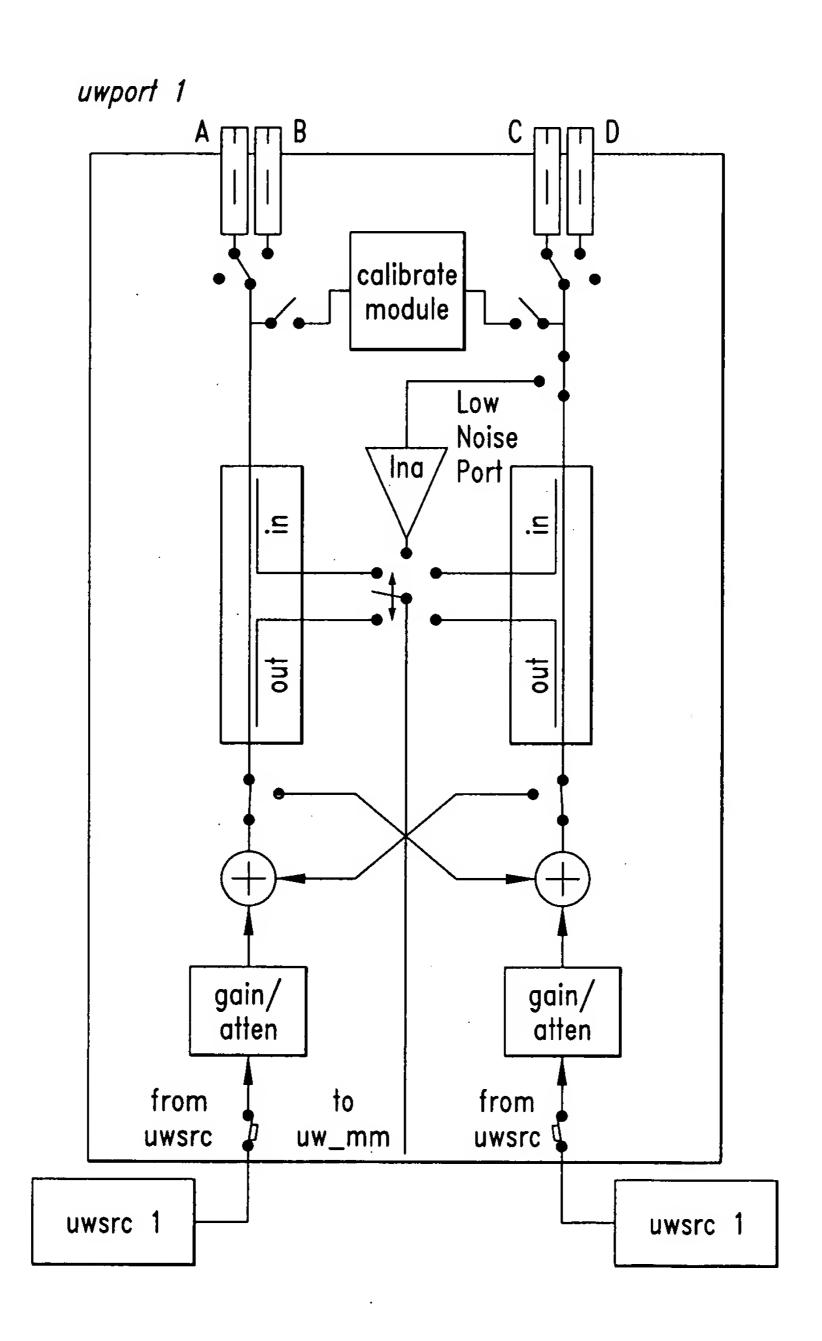


FIG. 5



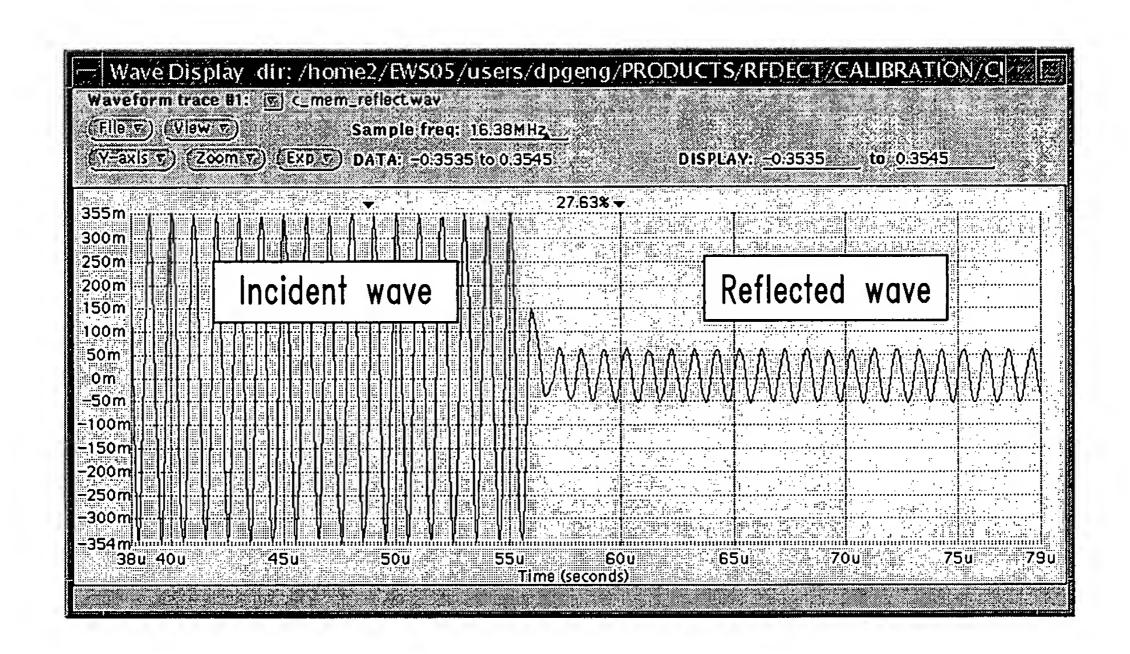
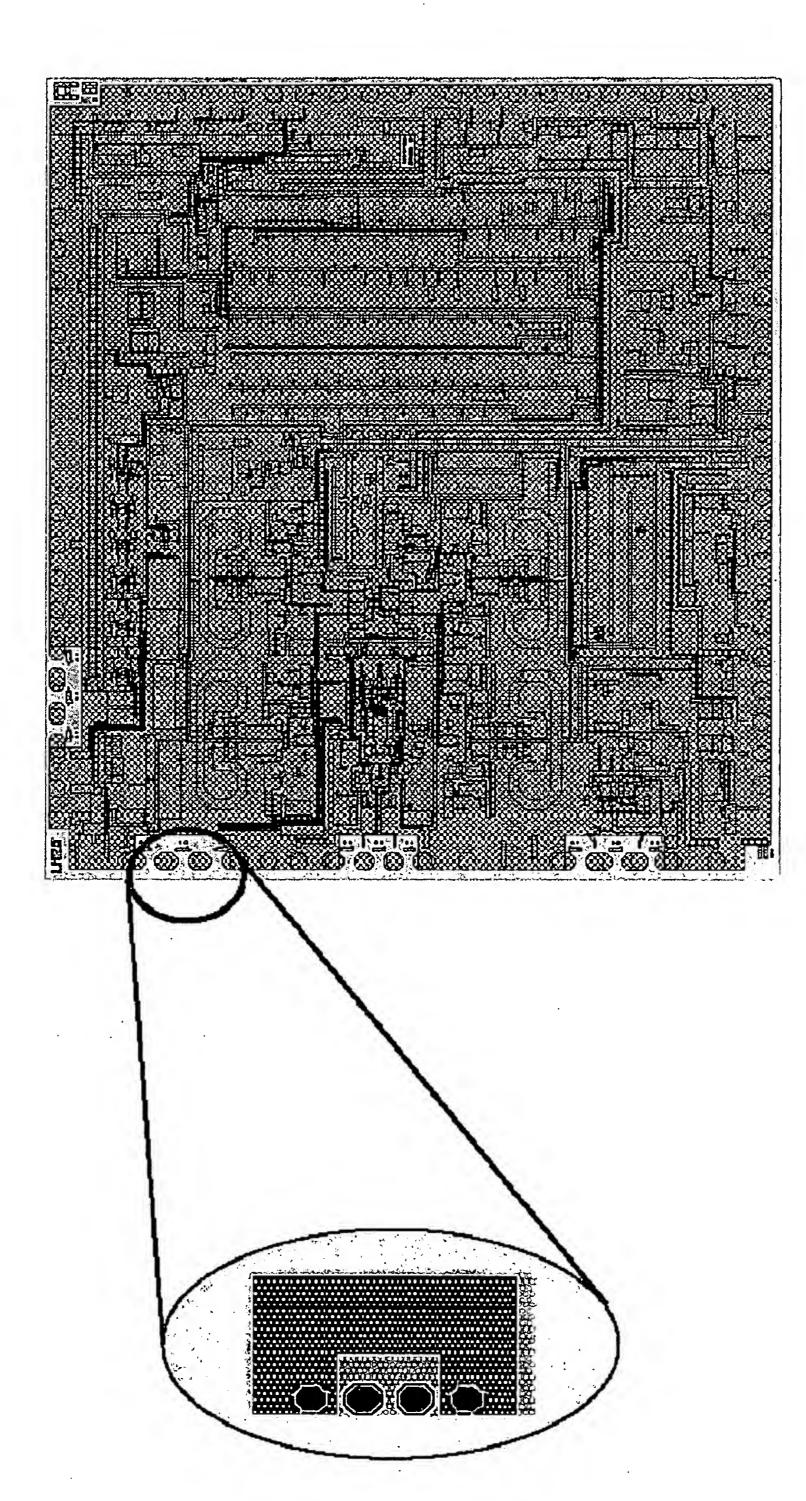


FIG. 6





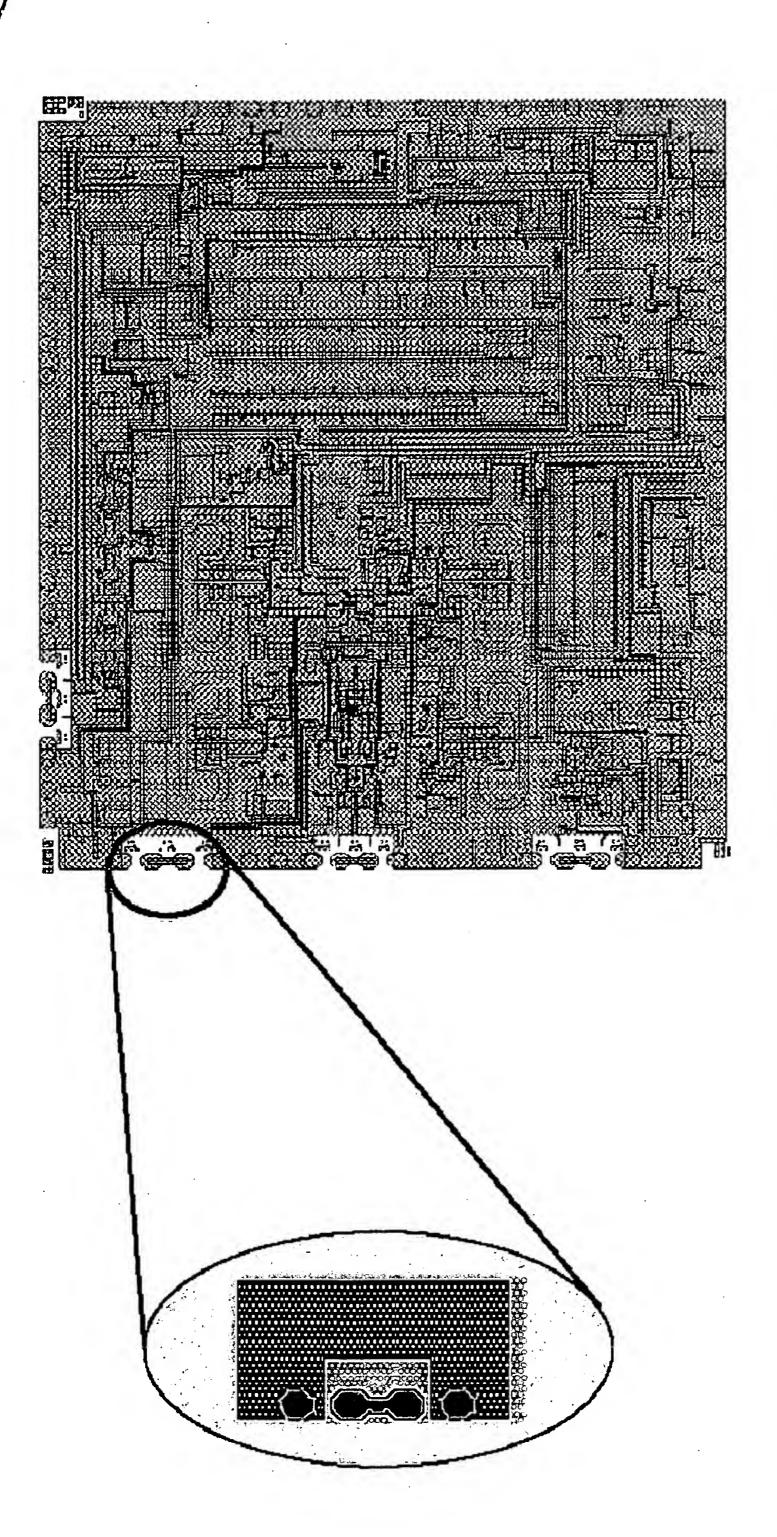
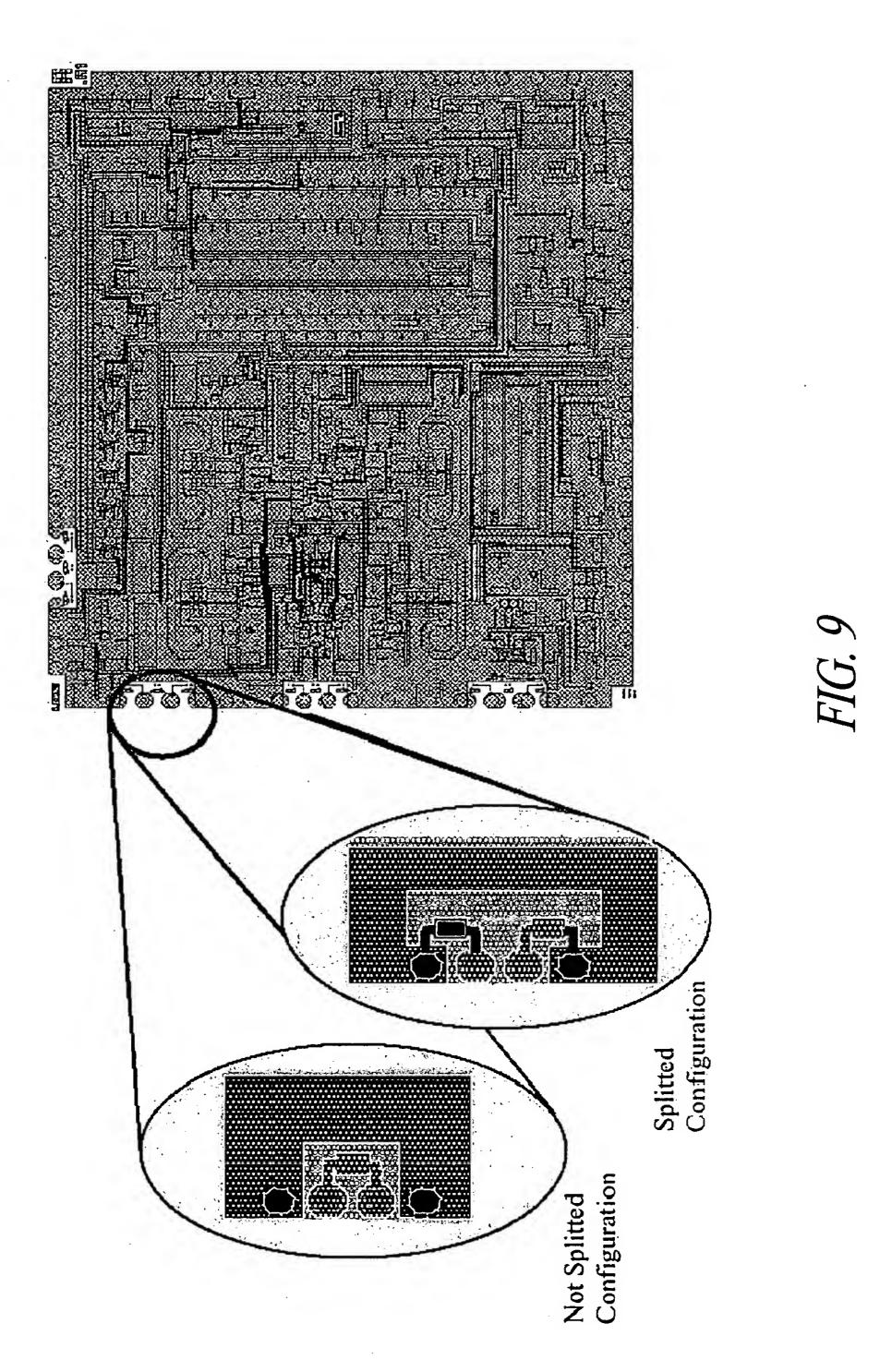


FIG. 8





MAR 0 8 2004 CS

FIG. 10

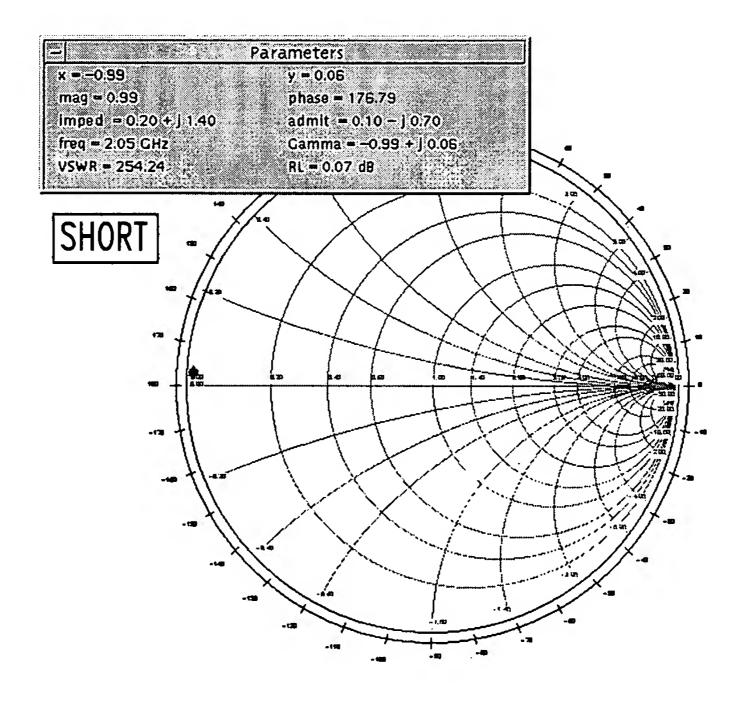


FIG. 11



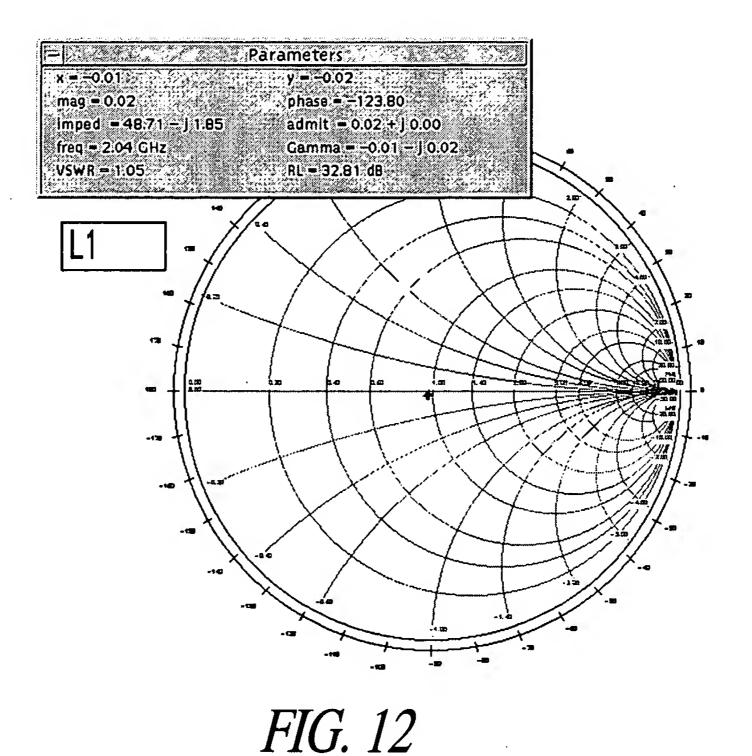


FIG. 13

MAR 0 8 2004 5

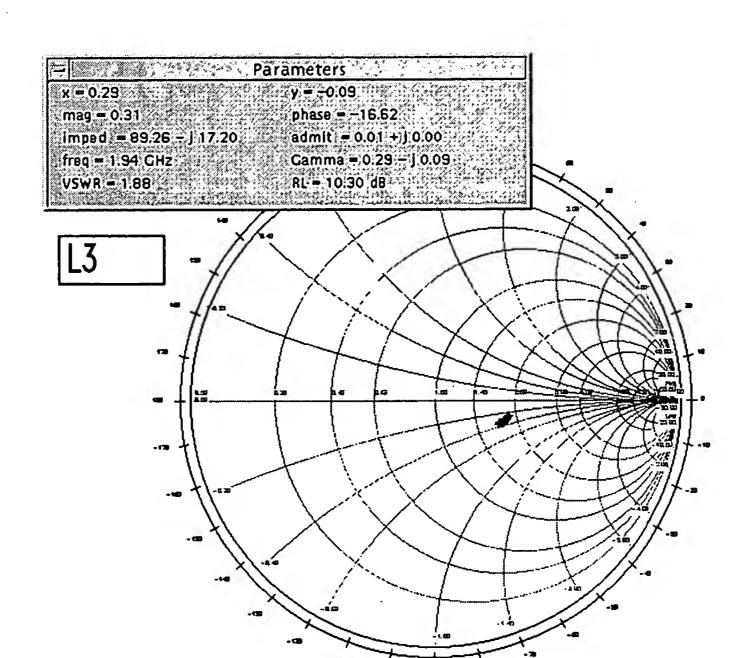


FIG. 14

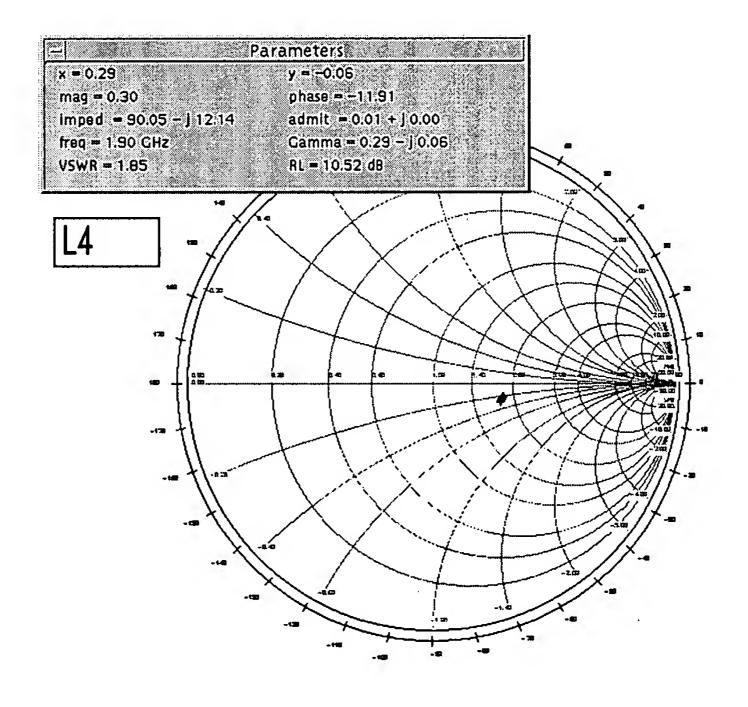


FIG. 15



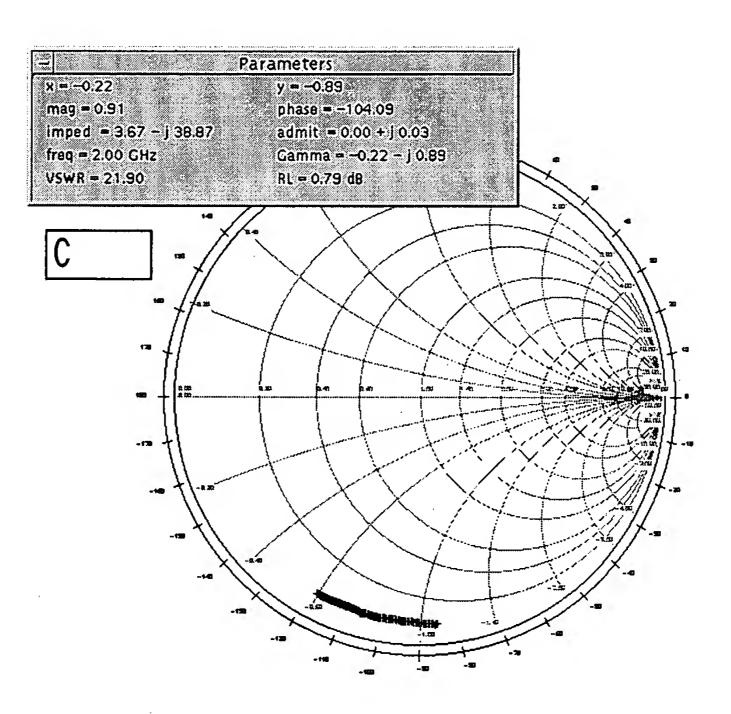


FIG. 16

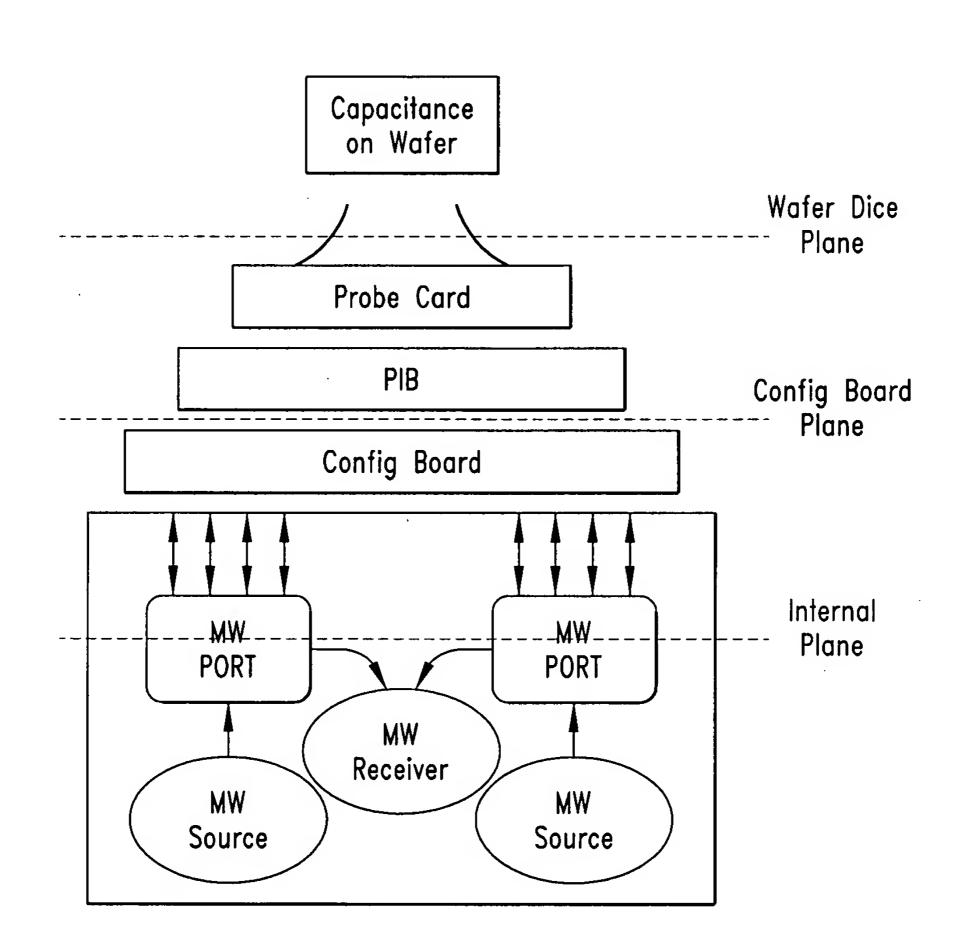


FIG. 17

Title: TEST BOARD DE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY ON AN AUTOMATIC TESTING EQUIPMENT FOR IC WAFERS Express Mail No. EV336594715US "REPLACEMENT SHEET"

EQUIPMENT FOR IC WAFERS Express Mail No. EV336594715US Inventor(s): Giuseppe Di Gregorio et al. Serial No. 10/033,364

Docket No. 856063.678

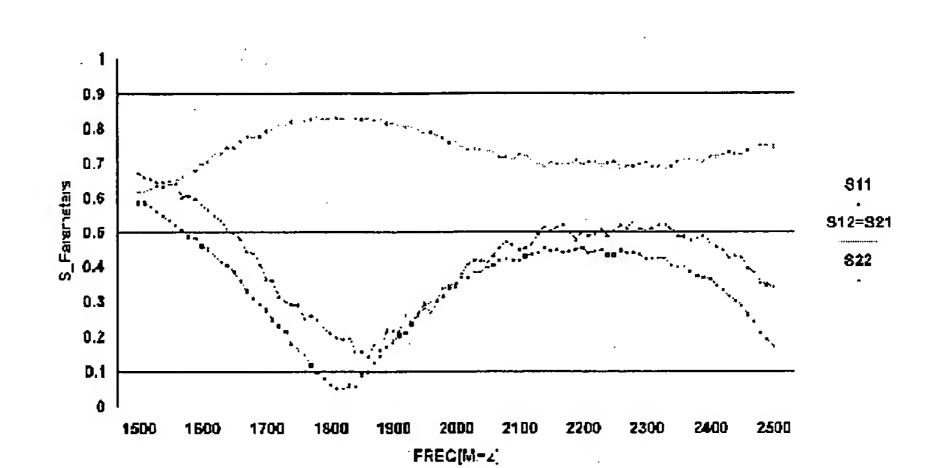


FIG. 18

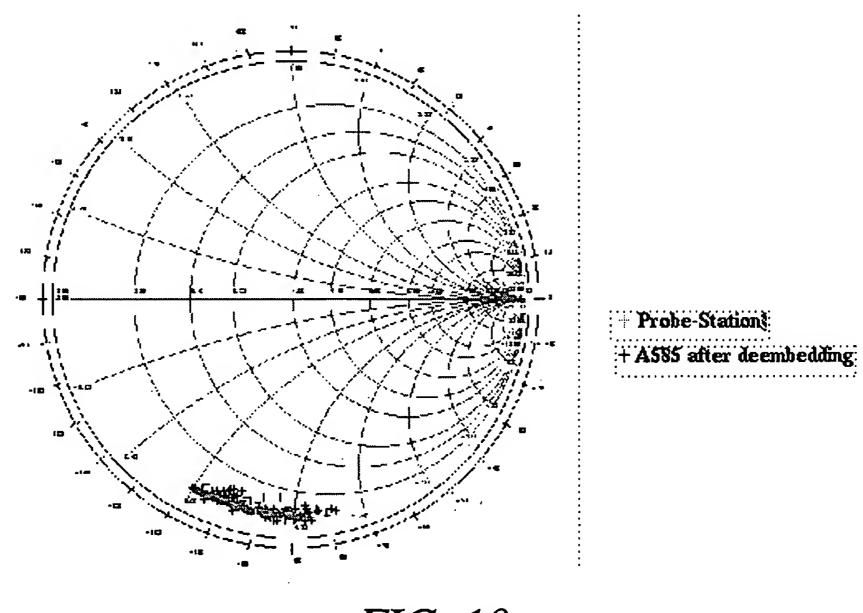
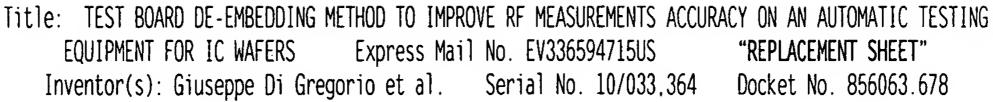


FIG. 19





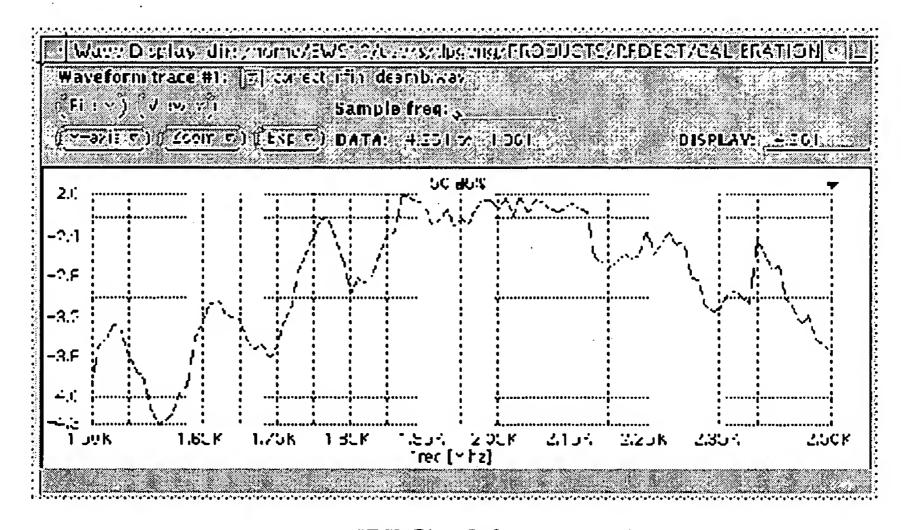


FIG. 20

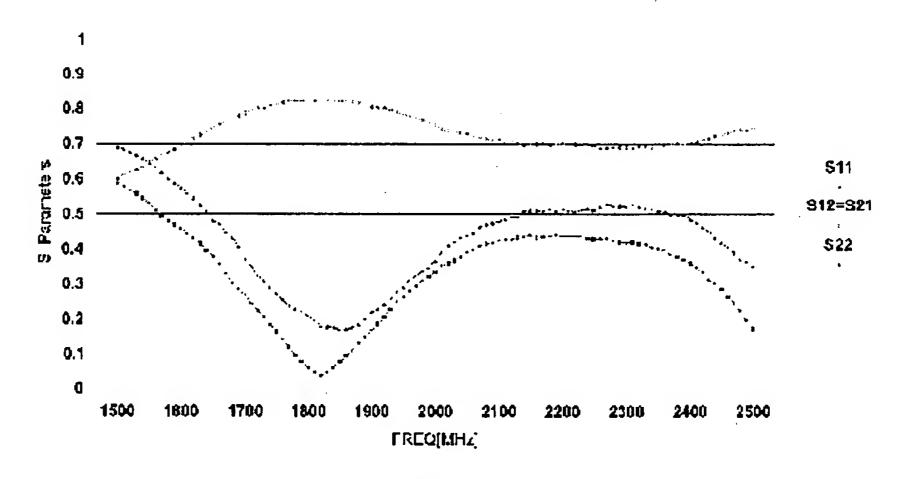
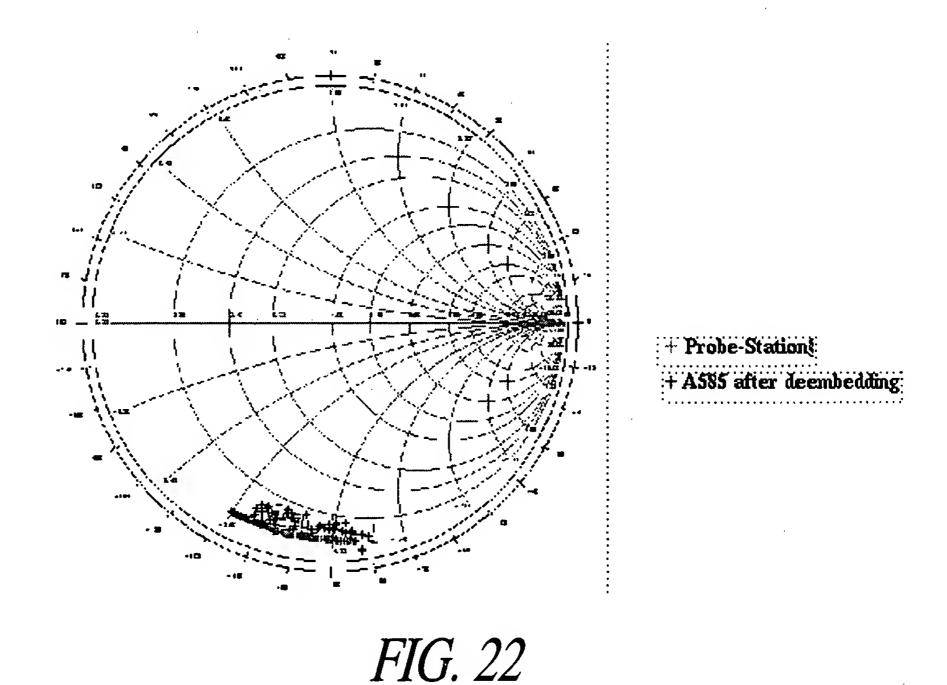


FIG. 21





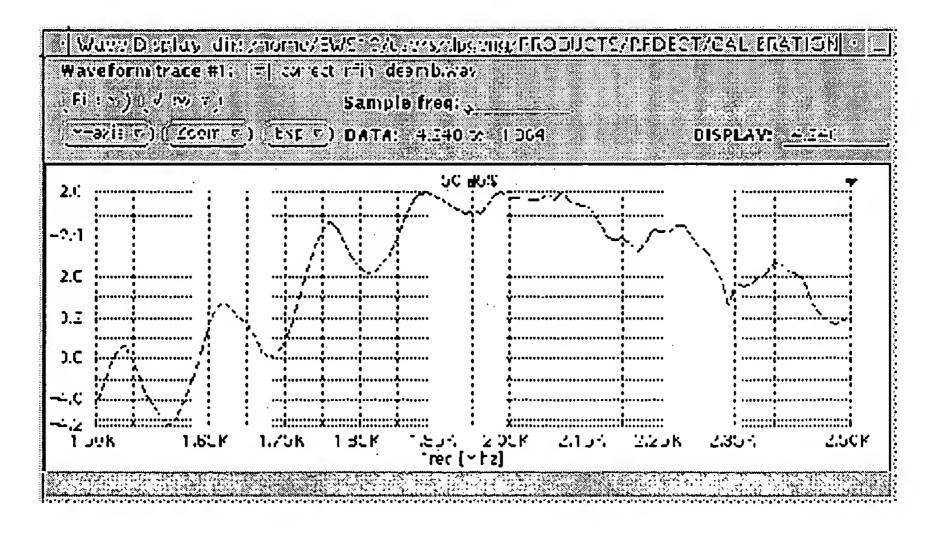


FIG. 23

Title: TEST BOARD DE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY ON AN AUTOMATIC TESTING EQUIPMENT FOR IC WAFERS Express Mail No. EV336594715US "REPLACEMENT SHEET"

Inventor(s): Giuseppe Di Gregorio et al. Serial No. 10/033,364 Docket No. 856063.678



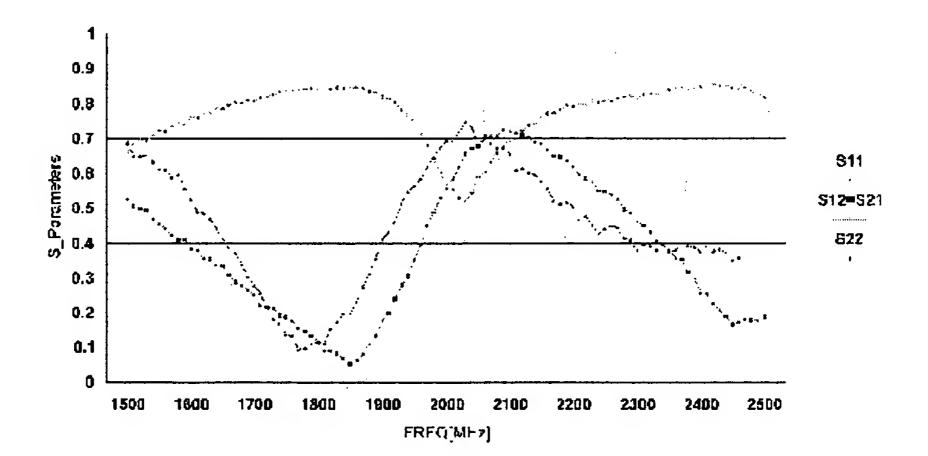


FIG. 24

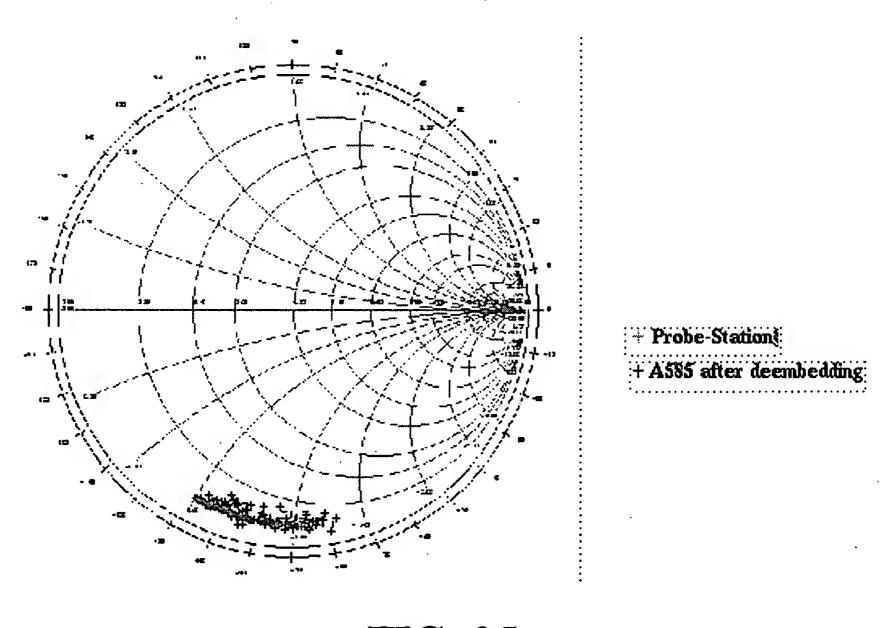


FIG. 25



| Wave | Display | dir: / nome/EWS1 (/) | everylpg.virg/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/PRODUCTS/P

FIG. 26

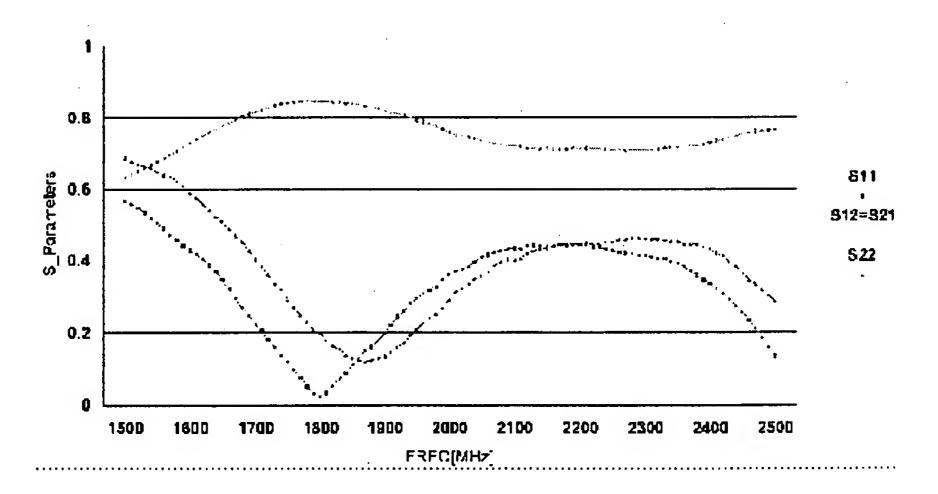
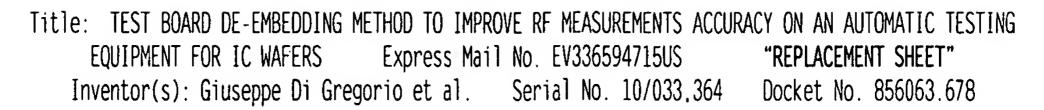
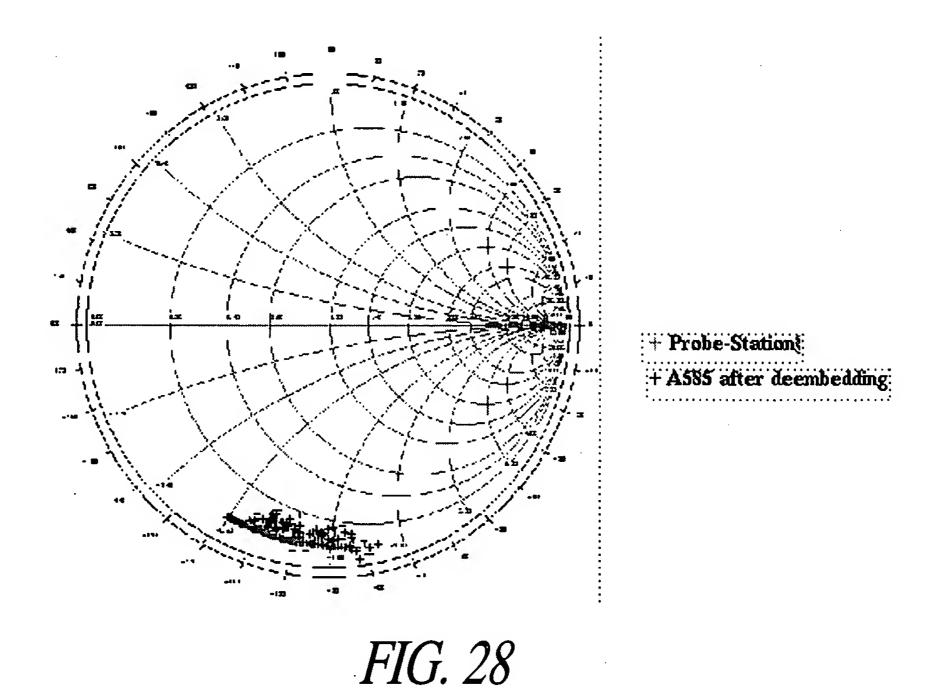


FIG. 27







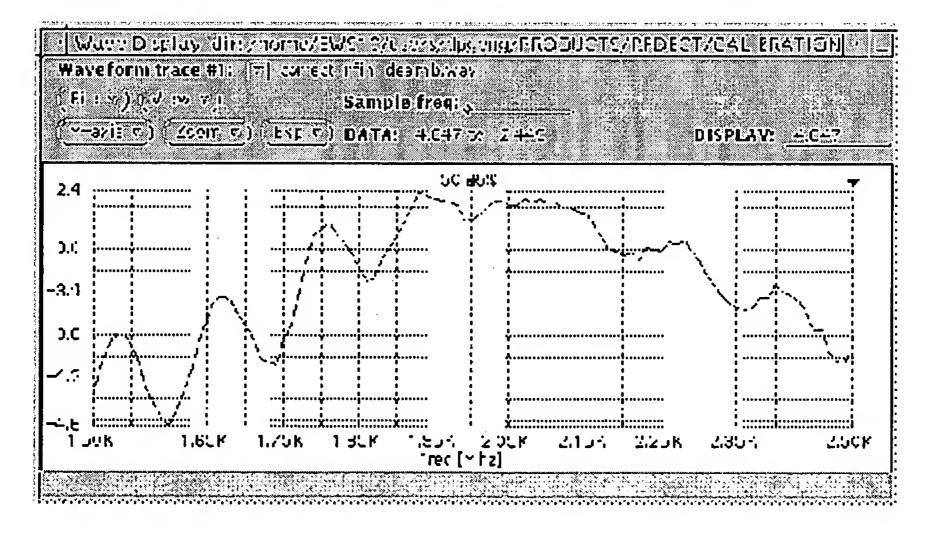


FIG. 29